



659.00 EUR
incl. 19% VAT, plus [shipping](#)

- Fanless Black Aluminum Enclosure
- Support Intel LGA1151 Coffee Lake Processors
- Supports DDR4-2133 SODIMM up to 32GB
- Supports up to 3 Displays, 1* DMI, 2* DP
- 1* 2.5" SATA3 6Gb/s Internal Drive Bay
- 1* M.2-2242/2260/2280 Slot for SSD
- Support Onboard TPM IC
- 120W 19V AC Adapter
- 264 (W) x 199.4 (D) x 58 (H) mm

MB Model	- JNF797-Q370 Series/ MINI-ITX
Part No.	- HBJC501F797-Q37-B (non-WIFI) - HBJC501F797WQ37-B (WIFI)
BIOS	- AMI SMT Flash ROM
CPU/Chipset	- Intel® LGA1151 Coffee Lake Processor (Max. TDP 35W) - Intel® Q370 chipset Notes: When the system runs, CPU will automatically adjust its working clock frequency according to changing workload.
Memory	2 * SO-DIMM slots / dual channel DDR4-2400/2666 up to 32GB total
Storage	- 1 * 2.5" SATA3 6Gb/s internal drive bay (only support 2.5" HDD with a height ≤ 10mm) - 1 * M.2-2242/2260/2280 (M-KEY) slot for SSD
Network	- 2 * Intel Gigabit LAN (i219LM, i211AT) - 1 * M.2-2230 (E-KEY) slot for WIFI module expansion
Rear Panel I/O	- 4 * USB 3.1 ports (Gen. 2) - 1 * HDMI (Max Resolution: 4096 x 2160@30Hz) - 2 * DP (Max Resolution: 4096 x 2304@60Hz) - 2 * RJ45 (Intel GbE, 1 * i219-LM, 1 * i210-AT) - 1 * Audio - 2 * COM (RS232/422/485) - 2 * Antenna holes (HBJC501F797WQ37-B only) - 1 * DC-In
Front Panel I/O	- 1 * Power button, 1 * HDD LED - 2 * USB 2.0 ports
Internal Expansion	- Support TPM1.2/2.0 (on board option) - SIM card slot

Power Source	– AC to DC Adapter 19VDC-6.3A 120W
Certifications	– CE, FCC, LVDS, RoHS, ErP Ready
Temperature	– Operating Temperature: -20 ~ 50° C (The test environment is closed and windless) – Storage Temperature: -10 ~ 70° C – Humidity : 90% , non-condensing
Dimensions	– 264 (W) x 199.4 (D) x 58 (H) mm
Packing	– Net Weight: 4.2KG – Gross Weight: 5KG – Color Box dimension: 406 (W) * 148 (D) * 380 (H) mm
OS Support	– Windows 10, Linux
Warranty	– 2 Year limited warranty